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April 1st, 2010 Renesas Electronics Corporation

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MOS FIELD EFFECT TRANSISTOR NP50P06SDG

SWITCHING P-CHANNEL POWER MOSFET

DESCRIPTION

The NP50P06SDG is P-channel MOS Field Effect Transistor designed for high current switching applications.

ORDERING INFORMATION

PART NUMBER	LEAD PLATING	PACKING	PACKAGE	
NP50P06SDG-E1-AY Note			TO 050 (MD 07//)	
NP50P06SDG-E2-AY Note	P06SDG-E2-AY Note Pure Sn (Tin)	Tape 2500 p/reel	TO-252 (MP-3ZK)	

Note Pb-free (This product does not contain Pb in external electrode.)

FEATURES

- Super low on-state resistance
- $R_{DS(on)1}$ = 16.5 m Ω MAX. (VGS = -10 V, ID = -25 A)
- $R_{DS(on)2}$ = 23.0 m Ω MAX. (V_{GS} = -4.5 V, I_D = -25 A)
- Low input capacitance
- Ciss = 5000 pF TYP.

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (V _{GS} = 0 V)	VDSS	-60	V
Gate to Source Voltage (VDS = 0 V)	Vgss	∓20	V
Drain Current (DC) (Tc = 25°C)	D(DC)	∓50	А
Drain Current (pulse) Note1	D(pulse)	∓150	А
Total Power Dissipation (Tc = 25° C)	P _{T1}	84	W
Total Power Dissipation (T _A = 25°C)	Pt2	1.2	W
Channel Temperature	Tch	175	°C
Storage Temperature	Tstg	-55 to +175	°C
Single Avalanche Current Note2	las	32	А
Single Avalanche Energy Note2	Eas	102	mJ

<R>

Notes 1. PW \leq 10 μ s, Duty Cycle \leq 1%

2. Starting T_{ch} = 25°C, V_{DD} = -30 V, R_G = 25 Ω , V_{GS} = $-20 \rightarrow 0$ V

THERMAL RESISTANCE

Channel to Case Thermal Resistance	Rth(ch-C)	1.78	°C/W
Channel to Ambient Thermal Resistance	Rth(ch-A)	125	°C/W

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The mark <R> shows major revised points.

The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.



(TO-252)

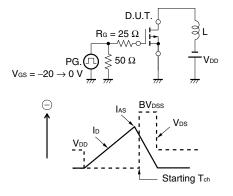
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	IDSS	V _{DS} = -60 V, V _{GS} = 0 V			-10	μA
Gate Leakage Current	lgss	V _{GS} = ∓20 V, V _{DS} = 0 V			∓100	nA
Gate to Source Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = -250 μA	-1.0	-1.6	-2.5	V
Forward Transfer Admittance Note	y _{fs}	V _{DS} = -10 V, I _D = -25 A	15	33		S
Drain to Source On-state Resistance Note	RDS(on)1	V _{GS} = -10 V, I _D = -25 A		13.2	16.5	mΩ
	RDS(on)2	V _{GS} = -4.5 V, I _D = -25 A		14.9	23.0	mΩ
Input Capacitance	Ciss	V _{DS} = -10 V,		5000		pF
Output Capacitance	Coss	V _{GS} = 0 V,		600		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		300		pF
Turn-on Delay Time	td(on)	V_{DD} = -30 V, I _D = -25 A,		13		ns
Rise Time	tr	V _{GS} = -10 V,		13		ns
Turn-off Delay Time	td(off)	R _G = 0 Ω		405		ns
Fall Time	tr			180		ns
Total Gate Charge	QG	$V_{DD} = -48 V,$		100		nC
Gate to Source Charge	Q _{GS}	V _{GS} = -10 V,		11		nC
Gate to Drain Charge	Qgd	I _D = -50 A		30		nC
Body Diode Forward Voltage Note	VF(S-D)	IF = -50 A, V _{GS} = 0 V		0.97	1.5	V
Reverse Recovery Time	trr	IF = -50 A, V _{GS} = 0 V,		50		ns
Reverse Recovery Charge	Qrr	di/dt = -100 A/µs		72		nC

ELECTRICAL CHARACTERISTICS (TA = 25°C)

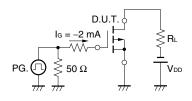
Note Pulsed test PW \leq 350 μ s, Duty Cycle \leq 2%

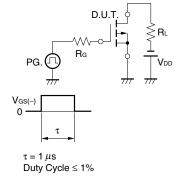
TEST CIRCUIT 1 AVALANCHE CAPABILITY

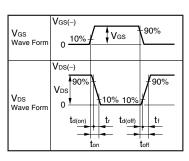
TEST CIRCUIT 2 SWITCHING TIME



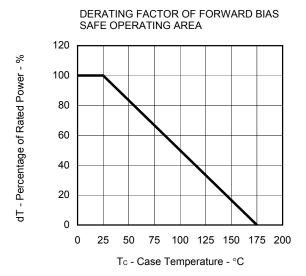
TEST CIRCUIT 3 GATE CHARGE

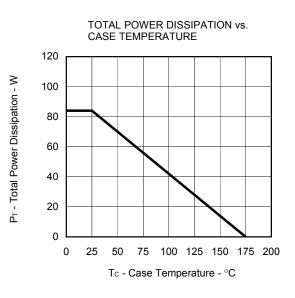




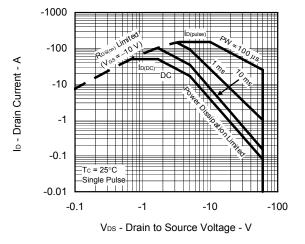


TYPICAL CHARACTERISTICS (TA = 25°C)

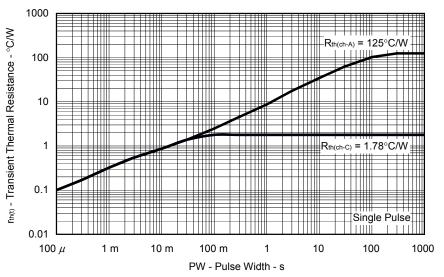




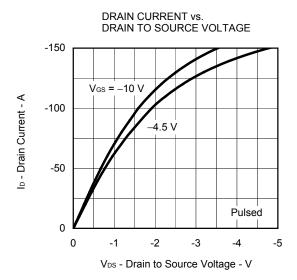
FORWARD BIAS SAFE OPERATING AREA



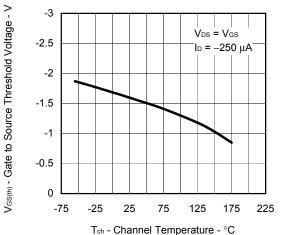
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

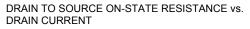


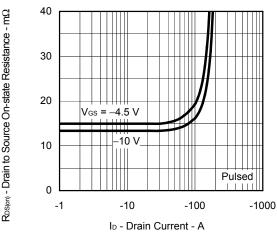
Data Sheet D19073EJ2V0DS



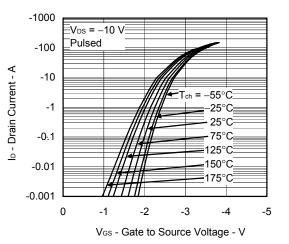




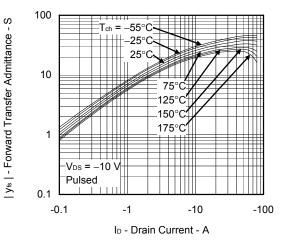




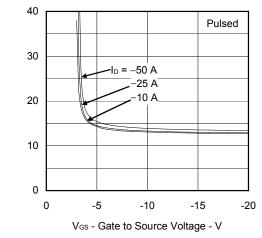
FORWARD TRANSFER CHARACTERISTICS



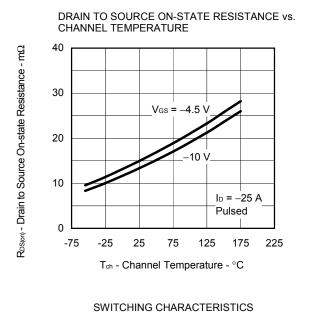
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT

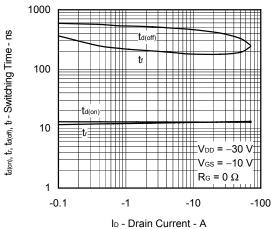


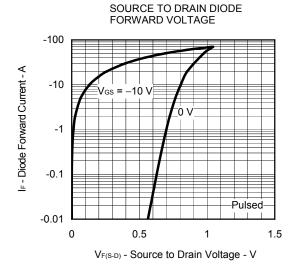




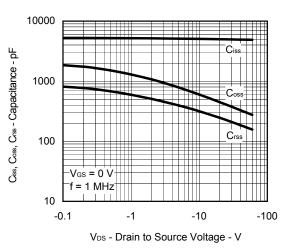
RDS(on) - Drain to Source On-state Resistance - m0



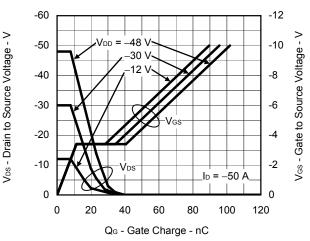


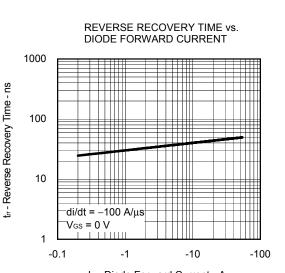


CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



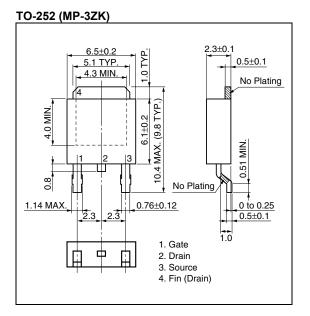
DYNAMIC INPUT/OUTPUT CHARACTERISTICS



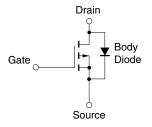


IF - Diode Forward Current - A

PACKAGE DRAWING (Unit: mm)



EQUIVALENT CIRCUIT



Remark Strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

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